FS1406 µPOL[™]



DATASHEET

6A Rated μPOL[™] Buck Regulator with Integrated Inductor and Digital Power System Management

Features

- µPOL[™] package with output inductor included
- Small size: <u>3.3mm x 3.3mm x 1.5mm</u>
- Continuous 6A load capability
- Plug and play: no external compensation required
- Programmable operation using the I²C serial bus
- Wide input voltage range: 4.5–16V
- Adjustable output voltage: 0.6–2.64V, ±0.5% initial accuracy
- Enabled input, programmable under-voltage lock-out (UVLO) circuit
- Open-drain power-good indicator
- Built-in protection features
- Operating temperature from -40°C to +125°C
- Lead-free and halogen-free
- Compliant with EU Directives REACH and RoHS 6

Applications

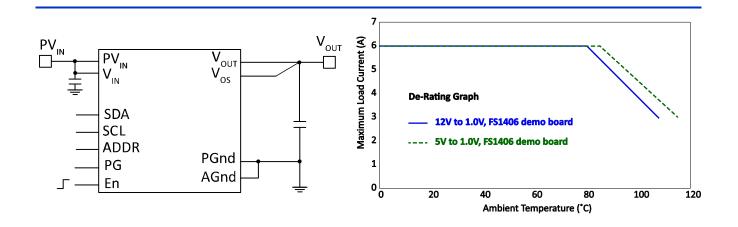
- Storage applications
- Telecom and networking applications
- Industrial applications
- Server applications
- Distributed point-of-load power architectures
- Computing peripheral voltage regulation
- General DC-DC conversion

Description

The FS1406 is an easy-to-use, fully integrated and highly efficient micro-point-of-load (μ POL^M) voltage regulator. The on-chip pulse-width modulation (PWM) controller and integrated MOSFETs, plus incorporated inductor and capacitors, result in an extremely compact and accurate regulator. The low-profile package is suitable for automated assembly using standard surface-mount equipment.

Developed by a cross-functional engineering team, the design exemplifies best practice and uses class-leading technologies. From early in the integrated circuit design phase, designers worked with application and packaging engineers to select compatible technologies and implement them in ways that reduce compromise. The ability to program aspects of the FS1406's operation using the Inter-Integrated Circuit (I²C) protocol is unique in this class of product. Developing and optimizing all of these elements together has yielded the smallest, most efficient and fully featured 6A µPOL[™] currently available.

The built-in protection features include pre-biased start-up, soft-start protection, over-voltage protection, thermally compensated over-current protection with hiccup mode, thermal shut-down with auto-recovery.



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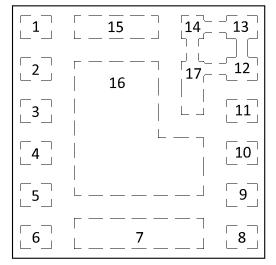


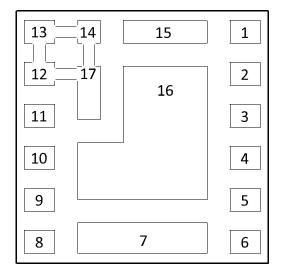
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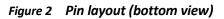


Pin configuration









Pin functions

Pin Number	Name	Description			
1	SDA	I^2 C Data Serial Input/Output line. Pull up to bus voltage with a 4.99kΩ resistor. If unused tie to AGnd.			
2	PG	Power Good status. Open drain of an internal MOSFET. Pull up to V_{cc} – pin 10 or an external bias voltage (Figure 7) – with a 49.9k Ω resistor.			
3	En	Enable. Switches the FS1406 on and off. Can be used with two external resistors to set an external UVLO (Figure 6).			
4	SCL	I^2 C Clock line. Pull up to bus voltage with a 4.99kΩ resistor. If unused, tie to AGnd.			
5	Vos	V_{OUT} sense pin. Connect directly to the regulator output (V_{OUT}).			
6	ADDR	Address. Connect to AGnd through a resistor to program FS1406 address (page 16).			
7	Vout	Regulator output voltage. Place output capacitors between this pin and PGnd (pin 8).			
8, 16	PGnd	Power ground. Serves as a separate ground for the MOSFETs. Connect to the power ground plane in the application.			
9	AGnd	Signal ground. Serves as the ground for the internal reference and control circuitry.			
10	V _{cc}	Supply voltage. May be an input bias for an external V _{CC} voltage or the output of the internal LDO regulator.			
11	V _{IN}	Input voltage. Input for the internal LDO regulator.			
12,13,14, 17	PVIN	Power input voltage. Input for the MOSFETs.			
15	V _{SW}	Test point for internal V _{sw} . Connect to an isolated pad on the PCB.			

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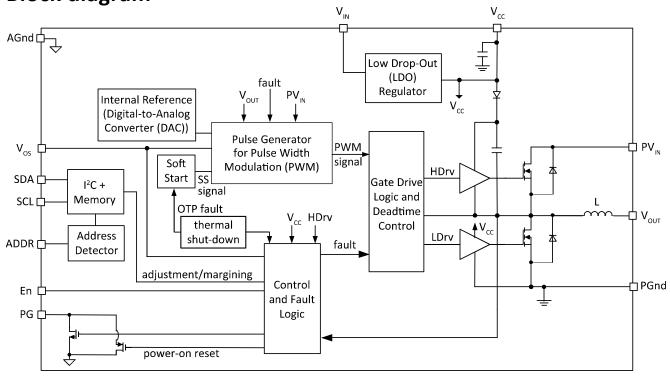


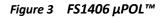




FS1406 μPOL[™]

Block diagram





Typical applications

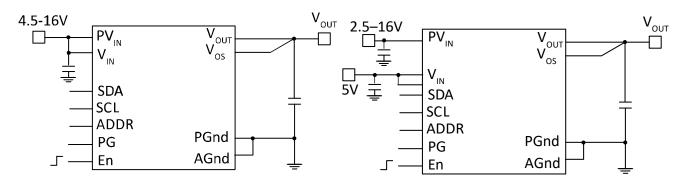
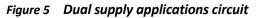


Figure 4 Single supply applications circuit



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Absolute maximum ratings

Warning: Stresses beyond those shown may cause permanent damage to the FS1406.

Note: Functional operation of the FS1406 is not implied under these or any other conditions beyond those stated in the FS1406 specification.

Reference	Range
PV _{IN} , V _{IN} , En to PGnd	-0.3V to 18V (Note 1, page 9)
V _{cc} to PGnd	-0.3V to 6V (Note 2, page 9)
Vos to AGnd	-0.3V to V _{CC} (Note 2, page 9)
PG to AGnd	-0.3V to V _{CC} (Note 2, page 9)
PGnd to AGnd	-0.3V to +0.3V
ESD Classification	2kV (HBM JESD22-A114)
Moisture Sensitivity Level	MSL 3 (JEDEC J-STD-020D)

Thermal Information		Range
Junction-to-Ambient Thermal Resistance Θ_{JA}		22.6°C/W
Junction to PCB Thermal Resistance OJ-PCB		2.36°C/W
Storage Temperature Range		-55°C to 150°C
Junction Temperature Range		-40°C to 150°C
Note: Θ_{JA} : FS1406 evaluation board and JEDEC specifications JESD 51-2A $\Theta_{J-c \ (bottom)}$: JEDEC specification JESD 51-8		

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Order information

Package details

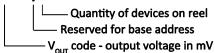
The FS1406 uses a µPOL[™] 3.3 mm x 3.3 mm package delivered in tape-and-reel format (Figure 33), with either 250 or 4000 devices on a reel.

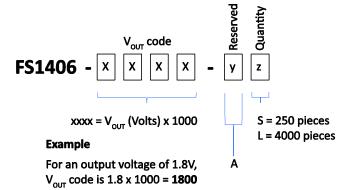
Standard part numbers

Output voltages of 0.6V to 2.64V are available.

	Part nu	umbers
νουτ	250 devices on a reel	4000 devices on a reel
0.60	FS1406-0600-AS	FS1406-0600-AL
0.70	FS1406-0700-AS	FS1406-0700-AL
0.75	FS1406-0750-AS	FS1406-0750-AL
0.80	FS1406-0800-AS	FS1406-0800-AL
0.90	FS1406-0900-AS	FS1406-0900-AL
1.00	FS1406-1000-AS	FS1406-1000-AL
1.05	FS1406-1050-AS	FS1406-1050-AL
1.10	FS1406-1100-AS	FS1406-1100-AL
1.20	FS1406-1200-AS	FS1406-1200-AL
1.80	FS1406-1800-AS	FS1406-1800-AL
2.50	FS1406-2500-AS	FS1406-2500-AL
2.64	FS1406-2640-AS	FS1406-2640-AL

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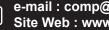


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Recommended operating conditions

Definition	Symbol	Min	Max	Units
Input Voltage Range with External V $_{cc}$ (Note 3, Note 5)	PVIN	2.5	16	
Input Voltage Range with Internal LDO (Note 4, Note 5)	PVIN, VIN	4.5	16	
Supply Voltage Range (Note 2)	V _{cc}	4.5	5.5	V
Output Voltage Range	Vo	0.6	2.64	
Continuous Output Current Range	lo	0	6	А
Operating Junction Temperature	Τı	-40	125	°C

Electrical characteristics

ELECTRICAL CHARACTERISTICS						
Unless otherwise stated, these spe	cifications apply over:	4.5V < PV _{IN} = V _{IN} < 16V, 0°C < T < 125°C				
Typical values are specified at $T_A =$	25°C					
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Supply Current		<u>.</u>				•
V _{IN} Supply Current (Standby)	I _{IN (STANDBY)}	Enable low		1		
V _{IN} Supply Current (Static)	IIN (STATIC)	No switching, En = 2V		2		
V _{IN} Supply Current (Dynamic)	I _{IN (DYN)}	En high, V _{IN} = 12V, V _{OUT} = 1.8V, F _{SW} =2MHz		19	25	mA
Soft-Start						•
Soft-Start Rate	SS _{RATE} (default)	(Note 7)		0.5		V/ms
Output Voltage			•			
	Vout (default)			1.8		V
Output Voltage Range	V (resolution)	V _{OUT} ≤ 1.8V		5		m\/
		V _{OUT} > 1.8V		10		mV
		T _J = 25°C, PV _{IN} = 12V, V _{OUT} = 1.8V (Note 6)		±0.5		
Accuracy		$25^{\circ}C < T_J < 125^{\circ}C, PV_{IN} = 12V,$ $0.6V \le V_{OUT} < 1.0V (Note 6)$	-1.2		+1.2	%
		$25^{\circ}C < T_J < 125^{\circ}C, PV_{IN} = 12V,$ $1.0V \le V_{OUT} \le 2.64V$ (Note 6)	-1		+1	
On-Time Timer Control						
On Time	T _{ON}	PV _{IN} = 12V, V _{OUT} = 1.8V, F _{SW} =2MHz	70	80	90	
Minimum On-Time	T _{ON(MIN)}	(Note 7)		50		ns
Minimum Off-Time	Toff(MIN)	PV _{IN} = 1.8V, V _{OUT} = 1.8V, F _{SW} =2MHz		220	256	
Internal Low Drop-Out (LDO) Regu	lator					
LDO Regulator Output Voltage	V _{cc}	5.5V < V _{IN} = 16V, 0 – 20mA	4.9	5.2	5.5	v
LDO Regulator Output voltage	V CC	4.5V <= V _{IN} < 5.5V, 0 – 20mA	4.3			v
Line Regulation	VLN	5.5V < V _{IN} = 16V, 20mA			50	mV
Load Regulation	VLD	0 – 20mA			100	
Short Circuit Current	Ishort	(Note 7)		70		mA

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ELECTRICAL CHARACTERISTICS

Unless otherwise stated, these specific	ations apply over: 4	.5V < PV _{IN} = V _{IN} < 16V, 0°C < T < 125°C					
Typical values are specified at T _A = 25°0	C						
Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Thermal Shut-Down							
Thermal Shut-Down	TSD (default)			145		°C	
Hysteresis				25		C	
Under-Voltage Lock-Out							
Vcc Start Threshold	VCC_UVLO(START)	Vcc Rising Trip Level	3.7	4.0	4.2		
Vcc Stop Threshold	VCC_UVLO(STOP)	Vcc Falling Trip Level	3.6	3.8	3.95	v	
Enable Threshold	En(ніgн)	Ramping Up	1.1	1.2	1.3	v	
	En(LOW)	Ramping Down	0.9	1	1.06		
Input Impedance	R _{EN}		500	1000	1500	kΩ	
Current Limit							
Current Limit Threshold	loc (default)	T _J = 25°C, PV _{IN} = 12V, V _{OUT} = 1.8V	7.2	7.8	8.5	А	
Hiccup Blanking Time	TBLK(HICCUP)			20		ms	
Over-Voltage Protection							
Output Over-Voltage Protection Threshold	V _{OVP} (default)	OVP Detect (Note 7) , V _{OUT} = 1.8V	115	120	125	Vos%	
Output Over-voltage Protection Delay	TOVPDEL			5		μs	
Power Good (PG)							
Power Good Upper Threshold	V _{PG(UPPER)} (default)	V _{OUT} Rising to 1.8V	85	90	95	V 9/	
Power Good Hysteresis	VPG(LOWER)	Vout Falling from 1.8V		5		Vos%	
Power Good Sink Current	IPG	PG = 0.5V, En = 2V		9		mA	

ELECTRICAL CHARACTERISTIC	S						
Unless otherwise stated, the Typical values are specified a	-		V _{IN} = V _{IN} < 16V, 0)°C < T < 125	°C		
Parameter	Symbol	Conditions	Fast-mo	de	Fast-mode	e Plus	
I ² C parameters		(Note 7 for all parameters)	Min	Max	Min	Max	Unit
I ² C bus voltage	VBUS		1.8	5.5	1.8	5.5	
LOW-level input voltage	VIL		-0.5	0.3V _{BUS}	-0.5	0.3V _{BUS}	
HIGH-level input voltage	VIH		0.7V _{BUS}		0.7V _{BUS}		
Hysteresis	V _{HYS}		0.05V _{BUS}		0.05V _{BUS}		
LOW-level output voltage 1	V _{OL1}	(open-drain or open- collector) at 3mA sink current; V _{DD} > 2 V,	0	0.4	0	0.4	V
LOW-level output voltage 2	V _{OL2}	(open-drain or open- collector) at 2mA sink current; $V_{DD} \leq 2 V$,	0	0.2V _{BUS}	0	0.2V _{BUS}	
10W lovel output ourrent		V _{OL} = 0.4 V,	3	-	3	-	
LOW-level output current	loι	V _{OL} = 0.6 V	6	-	6	-	mA

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ELECTRICAL CHARACTERISTICS

Unless otherwise stated, these specifications apply over: 4.5V < PV_{IN} = V_{IN} < 16V, 0°C < T < 125°C

Typical values are specified at	T _A = 25°C						1
Parameter	Symbol	Conditions	Fast-mode	2	Fast-mode Plus		
I ² C parameters		(Note 7 for all parameters)	Min	Max	Min	Max	Unit
Output fall time	TOF	From VIHmin to VILmax	20 × (V _{BUS} /5.5 V)	250	20 × (V _{BUS} /5.5 V)	125	
Pulse width of spikes that must be suppressed by the input filter	T _{SP}		0	50	0	50	ns
Input current each I/O pin	h		-10	10	-10	10	μA
Capacitance for each I/O pin	Cı		-	10	-	10	рF
SCL clock frequency	Fscl		0	400	0	1000	kHz
Hold time (repeated) START condition	Thd;sta	After this time, the first clock pulse is generated	0.6	-	0.26	-	
LOW period of the SCL clock	T _{LOW}		1.3	-	0.5	-	
HIGH period of the SCL clock	Тнібн		0.6	-	0.26	-	μs
Set-up time for a repeated START condition	T _{SU;STA}		0.6	-	0.26	-	
Data hold time	Thd;dat	I ² C-bus devices	0	-	0	-	
Data set-up time	T _{SU;DAT}		100	-	50	-	
Rise time of SDA and SCL signals	T _R		20	300	-	120	ns
Fall time of SDA and SCL signals	TF		20 × (V _{DD} /5.5 V)	300	20 × (V _{DD} /5.5 V)	120	
Set-up time for STOP condition	Tsu;sto		0.6	-	0.26	-	
Bus free time between a STOP and START condition	T _{BUF}		1.3	-	0.5	-	μs
Capacitive load for each bus line	Св		-	400	-	550	pF
Data valid time	T _{VD;DAT}		-	0.9	-	0.45	
Data valid acknowledge time	Тур;аск		-	0.9	-	0.45	μs
Noise margin at the LOW level	V _{NL}	For each connected	0.1V _{DD}	-	0.1V _{DD}	-	v
Noise margin at the HIGH level	V _{NH}	device, including hysteresis	0.2V _{DD}	-	0.2V _{DD}	-	V
SDA timeout	Тто		200		200		μs

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Notes

- 1 PGnd pin and AGnd pin are connected together
- 2 Must not exceed 6V
- 3 VIN is connected to Vcc to bypass the internal Low Drop-Out (LDO) regulator
- 4 V_{IN} is connected to PV_{IN} (for single-rail applications with PV_{IN}=V_{IN}=4.5V-5.5V)
- 5 Maximum switch node voltage should not exceed 22V
- 6 Hot and cold temperature performance is assured by correlation using statistical quality control, but not tested in production; performance at 25°C is tested and guaranteed in production environment
- 7 Guaranteed by design but not tested in production

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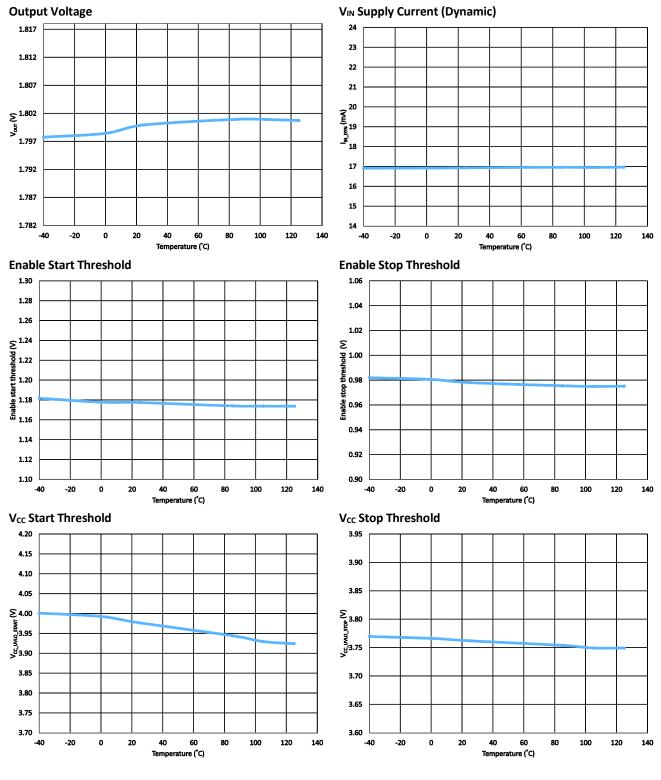








Temperature characteristics



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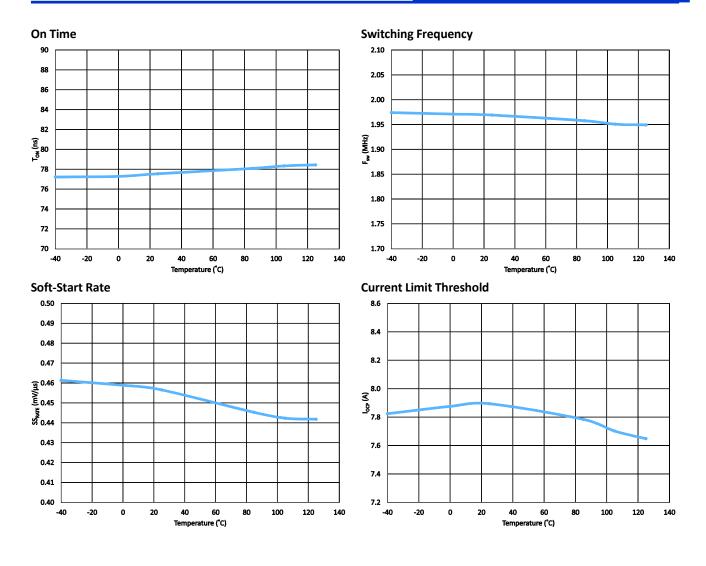
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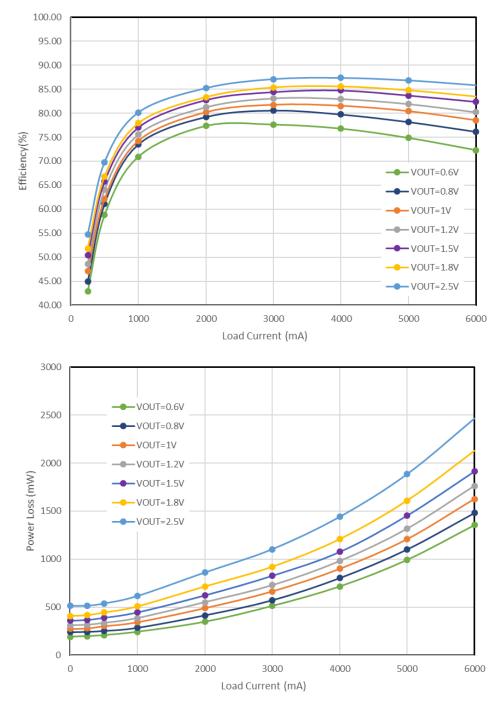




Efficiency characteristics

Typical efficiency and power loss at PV_{IN} = 12V

PVIN = 12V, Internal LDO used, Io = 0A-6A, room temperature, no air flow, all losses included



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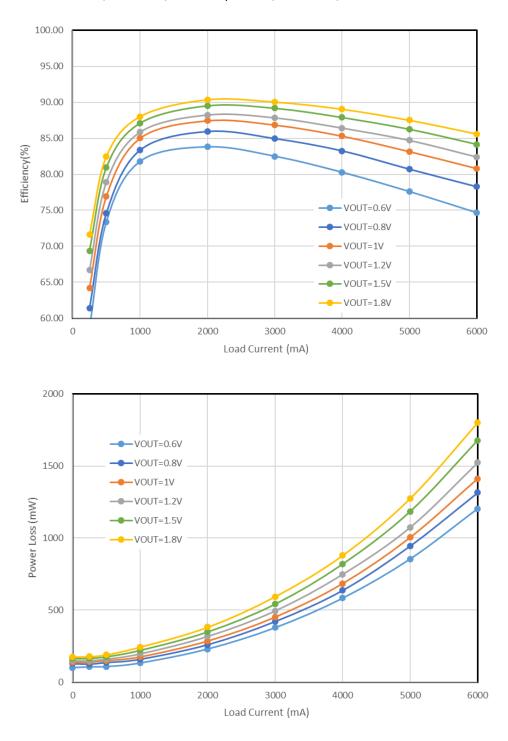


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Typical efficiency and power loss at PV_{IN} = 5V

PVIN = VIN = VCC = 5V, IO = 0A-6A, room temperature, no air flow, all losses included



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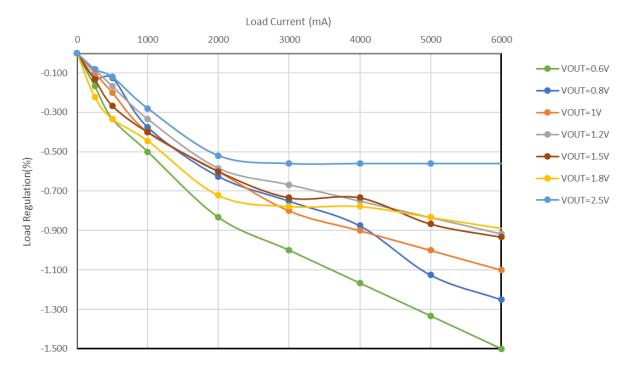


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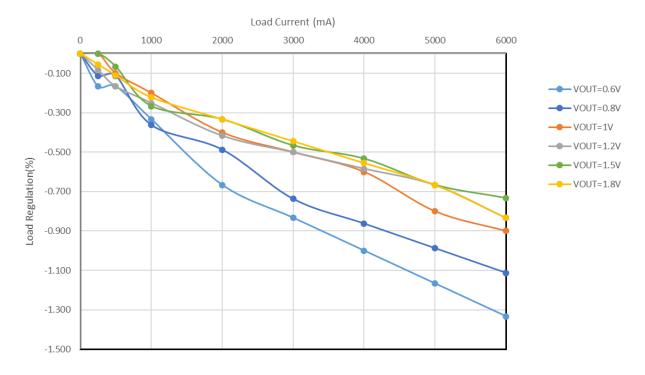


Typical load regulation

 PV_{IN} = 12V, internal LDO used, I_0 = 0A-6A, room temperature, no air flow







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Applications information

Overview

The FS1406 is an easy-to-use, fully integrated and highly efficient DC/DC regulator. Aspects of its operation, including output voltage and system optimization parameters, can be programmed using the I²C protocol. It uses a proprietary modulator to deliver fast transient responses. The modulator has internal stability compensation so that it can be used in a wide range of applications, with various types of output capacitors, without loop stability issues.

Bias voltage

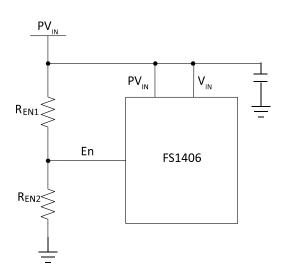
The FS1406 has an integrated Low Drop-Out (LDO) regulator, providing the DC bias voltage for the internal circuitry. The typical LDO regulator output voltage is 5.2V. For internally biased single-rail operation, the V_{IN} pin should be connected to the PV_{IN} pin (Figure 6). If an external bias voltage is used, the V_{IN} pin should be connected to the V_{CC} pin to bypass the internal LDO regulator (Figure 7).

The supply voltage (internal or external) rises with V_{IN} and does not need to be enabled using the En pin. Consequently, I²C communication can begin as soon as:

- V_{CC}_UVLO start threshold is exceeded •
- Memory contents are loaded •
- Initialization is complete •
- Address offset is read •
- Note: Until initialization is complete, a small leakage current (≈3.4µA) will flow from the device into the output. This may significantly pre-bias the output voltage in applications with long V_{IN}/V_{CC} rise times. To prevent this, a small load capable of sinking 3.4µA should be connected in such applications.

The I^2C bus may be pulled up either to V_{cc} or to a system I²C bus voltage. The FS1406 offers two ranges for the I²C bus voltage, defined by the user register bit Bus_voltage_sel.

Register	Bits	Name/Description
0x1A	[1]	Bus_voltage_sel
		0:1.8–2.5V, 1: 3.3–5V



Single supply configuration: internal LDO Figure 6 regulator, adjustable PV_{IN}_UVLO

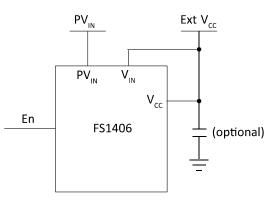


Figure 7 Using an external bias voltage

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I²C base address and offsets

The FS1406 has a user register called Base_address[7:0] stored in memory that sets its base I²C address. The default base address is 0x08. An offset of 0-3 is then defined by connecting the ADDR pin to the AGnd pin either directly or through a resistor. An address detector reads the resistance of the connection at startup and uses it to set the offset, which is added to the base I²C address to set the address at which the I²C master device will communicate with the FS1406.

To select offsets of 0 to 3, connect the pins as follows:

- 0 Ω (short ADDR to AGnd) 0
- +1 - 10kΩ
- 20kΩ +2
- >30.1kΩ +3

Soft-start and target output voltage

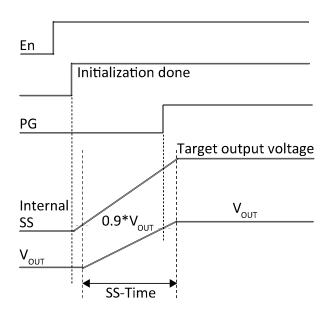
The FS1406 has an internal digital soft-start circuit to control output voltage rise-time and limit current surge at start-up. When V_{cc} exceeds its start threshold (V_{CC} _UVLO_(START)), the FS1406 exits reset mode; this initiates loading of the contents of the non-volatile memory into the working registers and calculates the address offset as described above.

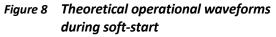
Once initialization is complete and the Enable (En) pin has been asserted (Figure 8), the internal reference soft-starts to the target output voltage at the rate defined by the user register bit SS_rate.

Register	Bits	Name/Description
0x14		SS_rate 0:0.5mV/μs (default), 1: 1 mV/μs

During initial start-up, the FS1406 operates with a minimum of high-drive (HDrv) pulses until the output voltage increases (see Switching frequency and minimum values for on-time, off-time on page 18). On-time is increased until V_{OUT} reaches the target value defined by the user register bit Vout_ high_byte and user register Vout_low_byte[7:0].

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Register	Bits	Name/Description
0x12	[0]	Vout_high_byte
0x13	[7:0]	Vout_low_byte

VOUT is set in increments of 5mV for target voltages up to 1.8V, and 10mV increments for target output voltages from 1.8V to 2.64V. Use the following equation to calculate the V_{OUT} code to enter into Vout_high_byte and Vout_low_byte[7:0]:

$$Vout_{code} = \frac{Vout_{target} - \frac{0.4 \times resolution}{0.005}}{resolution}$$

All voltages and resolutions are in Volts.

For example:

To set $V_{OUT} = 1V$ ($\leq 1.8V$, resolution of 5mV):

 $Vout_{code} = \frac{1 - \frac{0.4 \times 0.005}{0.005}}{0.005}$

120 is 078 in hexadecimal, therefore:

Set Vout_high_byte to 0

Set Vout_low_byte to 78 or (01111000)b

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To set V_{OUT} =2.5V (>1.8V, resolution of10mV):

$$Vout_{code} = \frac{2.5 - \frac{0.4 \times 0.01}{0.005}}{0.01} = 170$$

170 is 0AA in hexadecimal, therefore:

Set Vout_high_byte to 0

Set Vout_low_byte to AA or (10101010)_b

Over-current protection (OCP) and over-voltage protection (OVP) is enabled during soft-start to protect the FS1406 from short circuits and excess voltages respectively.

For maximum system accuracy, the recommended way to set the output voltage is by programming the user registers with the appropriate code. For optimum performance when using this approach, the change in output voltage should not exceed ±20% of the pre-set default output voltage.

However, another option is to combine an FS1406 pre-programmed to 0.6V with a feedback resistor divider (Figure 9). This gives system designers the flexibility to design all the power rails in the system across the output voltage range from 0.6V to 2.5V using a single part, at the expense of a worst-case error of no more than an additional -1%.

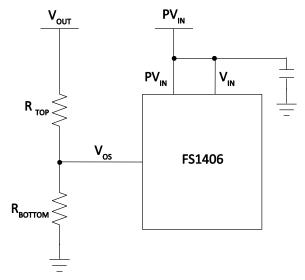


Figure 9 Setting the output voltage with an external resistor divider

The equation below describes the appropriate resistor divider selection to set the output voltage using a FS1406 programmed to 0.6V.

$$\frac{R_{TOP}}{R_{BOTTOM}} = 1.745 V_{OUT} - 1.047$$

It is recommended that system designers place a capacitor of 4.7pF to 47pF in parallel with R_{TOP}, for which a value of $40.2k\Omega$ is recommended. The recommended value for R_{BOTTOM} depends on the output voltage, as shown in the following table. If $R_{BOTTOM} > 100 k\Omega$, it is recommended to use a lower R_{TOP} such as 4.02k Ω , with the compensation capacitor in the 47pF to 470pF range.

V оит (V)	RTOP / RBOTTOM	Vout (V)	R TOP / R BOTTOM	
0.65	0.08725	1.55	1.658	
0.7	0.1745	1.6	1.745	
0.72	0.2094	1.65	1.833	
0.75	0.26175	1.7	1.92	
0.78	0.3141	1.75	2.008	
0.8	0.349	1.8	2.095	
0.85	0.4363	1.85	2.182	
0.88	0.489	1.9	2.27	
0.9	0.524	1.95	2.357	
0.95	0.611	2	2.445	
1	0.698	2.05	2.532	
1.05	0.785	2.1	2.619	
1.1	0.873	2.15	2.706	
1.15	0.96	2.2	2.794	
1.2	1.047	2.25	2.881	
1.25	1.135	2.3	2.968	
1.3	1.222	2.35	3.056	
1.35	1.309	2.4	3.143	
1.4	1.397	2.45	3.222	
1.45	1.484	2.5	3.318	
1.5	1.571			

For output voltages over 1.8V, the output current and input voltage ranges are restricted by minimum off-time (the shortest time for which the FS1406 can be switched off). FS1406-2500 and FS1406-2640 are recommended for 2.5V and 2.64V applications respectively.

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Pre-biased start-up

The FS1406 can start up into a pre-charged output smoothly, without causing oscillations and disturbances of the output voltage. When it starts up in this way, the Control and Synchronous MOSFETs are forced off until the internal Soft-Start (SS) signal exceeds the sensed output voltage at the V_{os} pin. Only then is the first gate signal of the Control MOSFET generated, followed by complementary turn on of the Synchronous MOSFET. The Power Good (PG) function is not active until this point.

Shut-down mechanisms

The FS1406 has two shut-down mechanisms:

- Hard shut-down or decay according to load Initiated by de-asserting the En pin. Both drivers switch off and the digital-toanalog converter (DAC) and soft-start are pulled down instantaneously.
- Soft-Stop or controlled ramp down Initiated by setting user register bit SoftStopEnable to 1 and user register bit SoftDisable to 1. The SS signal falls to 0 at the same rate as it rises during start-up; the drivers are disabled only when it reaches 0. The output voltage then follows the SS signal down to 0.

The SoftDisable bit must not be toggled while the part is enabled and switching. Instead, for applications requiring soft-stop, this bit must be set to 1 and, with the En pin asserted, the SoftStopEnable bit must be toggled to softstart or soft-stop the device.

By default, both the SoftDisable bit and the SoftStopEnable bit are 0, which means that soft-stop operation is disabled by default.

Register	Bits	Name/Description
0x14	[2]	SoftStopEnable
0x1C	[3]	SoftDisable

Switching frequency and minimum values for on-time, off-time and PV_{IN}

The switching frequency of the FS1406 depends on the output voltage. For an output voltage of 1.8V, the switching frequency is nominally 2MHz.

When the output voltage is set by programming the user registers, the appropriate switching frequency is also programmed at the factory. When the output voltage is set using an external switching divider, the resistor frequency automatically adjusts to the appropriate value:

$$F_{sw} = 650 kHz \times \frac{V_{OUT}}{0.6}$$

Therefore, with either method, system designers need not concern themselves with selecting the switching frequency and have one fewer design task to manage.

When input voltage is high relative to target output voltage, the Control MOSFET is switched on for shorter periods. The shortest period for which it can reliably be switched on is defined by minimum on-time (T_{ON(MIN)}). During start-up, when the output voltage is very small, the FS1406 operates with minimum on-time.

When input voltage is low relative to target output voltage, the Control MOSFET is switched on for longer periods. The shortest period for which it can be switched off is defined by minimum off-time (T_{OFF(MIN)}). The Synchronous MOSFET stays on during this period and its current is detected for over-current protection. This dictates the minimum input voltage that can still allow the device to regulate its output at the target voltage.

Figure 10 shows the minimum input voltage required for some typical output voltages. This curve assumes typical efficiency numbers; since it is affected by efficiency, system designers should validate the values in their own applications.

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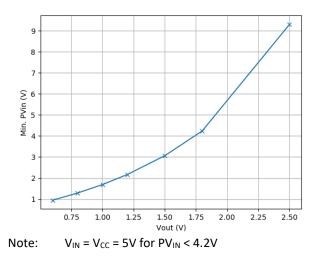
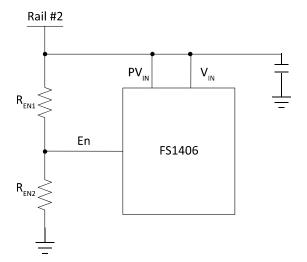


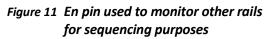
Figure 10 Minimum input voltage requirements

Enable (En) pin

The Enable (En) pin has several functions:

- It is used to switch the FS1406 on and off. It has a precise threshold, which is internally monitored by the UVLO circuit. If it is left floating, an internal 1MΩ resistor pulls it down to prevent the FS1406 being switched on unintentionally.
- It can be used to implement a precise input voltage UVLO. The input of the En pin is derived from the PV_{IN} voltage by a set of resistive dividers, R_{EN1} and R_{EN2} (Figure 6). Users can program the UVLO threshold voltage by selecting different ratios. This is a useful feature that stops the FS1406 regulating when PV_{IN} is lower than the desired voltage.
- It can be directly connected to PV_{IN} without external resistive dividers for some spaceconstrained designs. This is a useful feature for standalone start-up, when no logic signal is available to enable the FS1406.
- It can be used to monitor other rails for a specific power sequencing scheme (Figure 11).





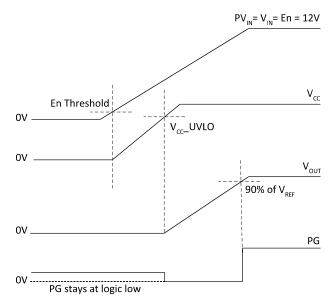


Figure 12 Start-up: PV_{IN}, V_{IN} and En pins tied together, PG pin pulled up to an external supply

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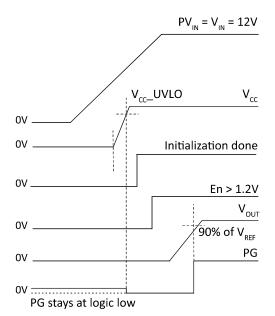


Figure 13 Start-up: En pin asserted after PV_{IN} and V_{IN}, PG pin pulled up to an external supply

For V_{OUT} to start up as defined by the soft-start rate requires correct sequencing:

- PV_{IN} must start up before V_{CC} and/or Enable.
- PV_{IN} must ramp down only after V_{CC} has ramped down below its UVLO threshold and/or Enable has been de-asserted.

Over-current protection (OCP)

Over-current protection (OCP) is provided by sensing the current through the R_{DS(on)} of the Synchronous MOSFET. When this current exceeds the OCP threshold, a fault condition is generated. This method provides several benefits:

- Provides accurate overcurrent protection without reducing converter efficiency (the current sensing is lossless)
- Reduces cost by eliminating a current-sense resistor
- Reduces any layout-related noise issues.

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The OCP threshold is defined by the user register bits OCSet.

Register	Bits	Name/Description			
0x15	[2:0]	OCSet			
		2:8A (default), 1:6A, 0: 4A			

The threshold is internally compensated so that it remains almost constant at different ambient temperatures.

When the current exceeds the OCP threshold, the PG and SS signals are pulled low. The Synchronous MOSFET remains on until the current falls to 0, then the FS1406 enters hiccup mode (Figure 14). Both the Control MOSFET and the Synchronous MOSFET remain off for the hiccup-blanking time. After this time, the FS1406 tries to restart. If an over-current fault is still detected, the preceding actions are repeated. The FS1406 remains in hiccup mode until the over-current fault is remedied.

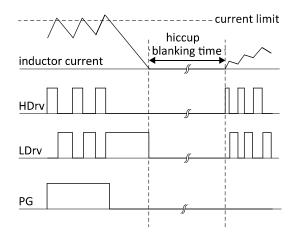


Figure 14 Illustration of OCP in hiccup mode

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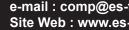
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Over-voltage protection (OVP)

Over-voltage protection (OVP) is provided by sensing the voltage at the V_{OS} pin. When V_{OS} exceeds the output OVP threshold for longer than the output OVP delay (typically 5µs), a fault condition is generated.

The OVP threshold is defined by the user register bits **OV_Threshold**.

Register	Bits	Name/Description
0x17	[1:0]	OV_Threshold
		0:105% of Vout
		1:110% of V _{OUT}
		2:115% of Vout
		3:120% of V_{OUT} (default)

The Control MOSFET is switched off immediately and the PG pin is pulled low. The Synchronous MOSFET is switched on to discharge the output capacitor.

The Control MOSFET remains latched off until reset by cycling either VCC or En. The voltage at the VOS pin falling below the output OVP threshold (with 5% hysteresis) does not switch on the Control MOSFET but it does switch off the Synchronous MOSFET to prevent build-up of negative current.

Figure 15 shows a timing diagram for over-voltage protection.

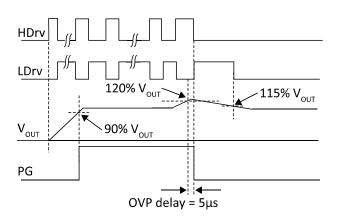


Figure 15 Illustration of latched OVP

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Over-temperature protection (OTP)

Temperature sensing is provided inside the FS1406. The OTP threshold is defined by the user register bits **OT_Threshold**.

Register	Bits	Name/Description
0x19	[1:0]	OT_Threshold
		0:75°C
		1: 85°C
		2: 125°C
		3: 145°C (default)

When the threshold is exceeded, thermal shutdown switches off both MOSFETs and resets the internal soft-start, but the internal LDO regulator is still in operation.

Automatic restart is initiated when the sensed temperature drops within the operating range. There is a 20°C hysteresis in the OTP threshold.

Power Good (PG)

Power Good (PG) behavior is defined by the user register bits **PGControl** and **PG_Threshold**.

Register	Bits	Name/Description
0x18	[1:0]	PG_Threshold
		0:80% of V _{OUT}
		1: 85% of Vout
		2: 90% of V_{OUT} (default)
		3: 95% of Vouт
0x14	[0]	PG_Control
		1:Threshold based (default)
		0: DAC based

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PG_Threshold bit

The user register bit PG_Threshold defines the PG threshold as a percentage of V_{OUT}. Hysteresis of 5% is applied to this, giving a lower threshold.

When Vos rises above the upper threshold, the PG signal is pulled high. When V_{OS} drops below the lower threshold, the PG signal is pulled low.

PGControl bit set to 1 (default)

Figure 16 shows PG behavior in this situation.

The behavior is the same at start-up and during normal operation. The PG signal is asserted when:

- En and V_{cc} are both above their thresholds
- No fault has occurred (including over-current, over-voltage and over-temperature)
- V_{OUT} is within the target range (determined by continuously monitoring whether Vos is above the PG threshold)

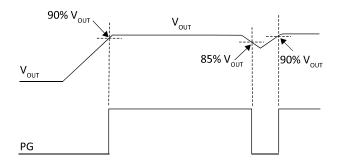


Figure 16 PG signal when PGControl bit=1

PGControl bit set to 0

Figure 17 shows PG behavior in this situation.

In normal operation, the PG signal behaves in the same way as when the **PGControl** bit is 1.

At start-up, however, the PG signal is asserted after soft-start is within 2% of target output voltage, not when Vos exceeds the upper PG threshold.

For pre-biased start-up, the PG signal is not active until the first gate signal of the Control MOSFET is generated.

FS1406 also integrates an additional PMOS in parallel to the NMOS internally connected to the PG pin (Figure 3). This PMOS allows the PG signal to stay at logic low, even if V_{CC} is low and the PG pin is pulled up to an external voltage not V_{cc} (Figure 12 and Figure 13).

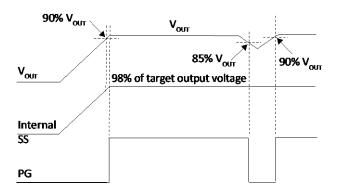


Figure 17 PG signal when PGControl bit=0

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Design example

Let us now consider a simple design example, using the FS1406 for the following design parameters:

- $PV_{IN} = V_{IN} = 12V$
- $V_{OUT} = 1.8V$.
- $F_{SW} = 2MHz$
- С_{ОUT} = 2 х 22µF •
- $C_{IN} = 2 \times 22 \mu F$
- Ripple Voltage = $\pm 1\% * V_{OUT}$
- $\Delta V_{OUT(MAX)} = \pm 3\% * V_{OUT}$ (for 50% load transient)

Input capacitor

The input capacitor selected for this design must:

- Handle the peak and root mean square (RMS) • input currents required by the FS1406
- Have low equivalent series resistance and inductance (ESR and ESL) to reduce input voltage ripple

MLCCs (multi-layer ceramic capacitors) are ideal. Typically, in 0805 case size, they can handle 2A RMS current with less than 5°C temperature rise.

For a buck converter operating at duty cycle D and output current Io, the RMS value of the input current is:

$$I_{RMS} = Io\sqrt{D(1-D)}$$

In this application, $I_0 = 6A$ and $D = \frac{V_{OUT}}{PV_{IN}} = 0.15$

Therefore, I_{RMS} = 2.14A and we can select two 22µF 16V ceramic capacitors for the input capacitors (C3216X5R1C226M160AB from TDK).

If the FS1406 is not located close to the 12V power supply, a bulk capacitor (68-330µF) may be used in addition to the ceramic capacitors.

For V_{IN} , which is the input to the LDO, it is recommended to use a 1µF capacitor very close to the pin. The V_{IN} pin should be connected to PV_{IN} through a 2.7 Ω resistor. Together, the 2.7 Ω resistor and $1\mu F$ capacitor filter noise on PV_{IN} .

Output voltage and output capacitor

The FS1406 is supplied pre-programmed and factory-trimmed in a closed loop to the target voltage specified for the part number. As a result, no external resistor divider is required and resistor tolerances are eliminated from the error budget.

The design requires minimal output capacitance to meet the target output voltage ripple and target maximum output voltage deviation under load transient conditions.

For the FS1406, the minimum number of output capacitors required to achieve target peak-to-peak V_{OUT} ripple is:

$$N_{MIN} = 4.09 \times \frac{\frac{(1-D)}{8CF_{SW}} + ESR(1-D) + \frac{ESL \times F_{SW} \times (1-D)^2}{D}}{\Delta V_{OUTripple(p-p)}}$$

where:

- N_{MIN} = minimum number of output capacitors
- D = duty cycle
- C = equivalent capacitance of each output capacitor
- F_{sw} = switching frequency
- *ESR* = equivalent series resistance of each output capacitor
- ESL = equivalent series inductance of each output capacitor
- $\Delta V_{OUTripple(p-p)}$ = target peak-to-peak V_{OUT} ripple

This design uses C2012X5R0J226K125AB from TDK; this is a 22µF MLCC, 0805 case size, rated at 6.3V. At 1.8V, accounting for DC bias and AC ripple derating, it has an equivalent capacitance of 12µF (C). Equivalent series resistance is $3m\Omega$ (ESR) and equivalent series inductance is 0.44nH (ESL).

Putting these parameters into the equation gives:

 $N_{\rm MIN} = 1.27$



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To meet the maximum voltage deviation ΔVo_{max} under a ΔI_o load transient, the minimum required number of output capacitors is:

$$\frac{0.244 \times \Delta I_o^2}{\Delta V_{omax} \times F_{sw} \times C}$$

where:

- $\Delta I_o = \text{load step}$
- Δ*V_{OUTmax}* = target maximum voltage deviation
- F_{sw} = switching frequency
- *C* = equivalent capacitance of each output capacitor

Again, using $C = 12\mu$ F, it can be seen that the minimum number of output capacitors required is 0.4.

In our design intended for space-constrained applications, therefore, we use two C2012X5R0J226K125AB capacitors.

It should be noted here that the calculation for the minimum number of output capacitors under a load transient makes some assumptions:

- a) No ESR or ESL
- b) Converter can saturate its duty cycle instantly
- c) No latency
- d) Step load (infinite slew rate)

Assumptions (a), (b) and (c) are liberal, whereas (d) is conservative. Therefore, in a real application, additional capacitance may be required to meet transient requirements and should be carefully considered by the system designer.

The typical application waveforms in Figure 26 and Figure 27 show the steady state V_{OUT} ripple as well as the voltage deviation in response to a 50% load

transient. These waveforms show that the selection of two 22μ F capacitors meets the design criteria.

It should be noted that even in the absence of a target V_{OUT} ripple or target maximum voltage deviation under load transient, at least one 22µF capacitor is still required in order to ensure stable operation without excessive jitter.

Up to six 22μ F capacitors may be used in the design. If more capacitance is required, it is recommended to use a capacitor with relatively high ESR (>3m Ω).

Note: The above discussion applies to designs that use FS1406-1800 devices with V_{OUT} tied to V_{OS} and no feedback divider. If an FS1406-0600 is used to generate 1.8V, with a resistive voltage divider between V_{OUT} and V_{OS}, the feedforward capacitor in parallel with the top resistor will allow greater flexibility in choice of output capacitance.

Figure 18 shows the minimum required output capacitance as a function of the output voltage. For an output voltage of 1V, the minimum capacitor requirement is dictated by the load transient specifications (< $\pm 3\%$ V_{OUT}). For output voltages above 1V, the output voltage ripple specification dominates (< $\pm 1\%$).

V_{cc} capacitor selection

FS1406 uses an on-package V_{cc} capacitor to ensure effective high-frequency bypassing. However, especially for applications that use an external V_{cc} supply, it is recommended that system designers place a 2.2 μ F/0603/X7R/10V capacitor on the application board as close as possible to the V_{cc} pin.

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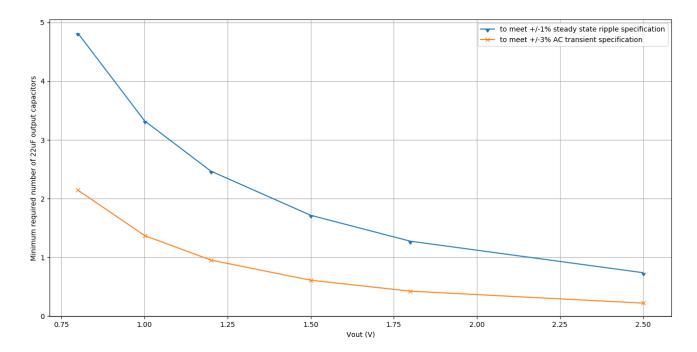


Figure 18 Minimum output capacitance

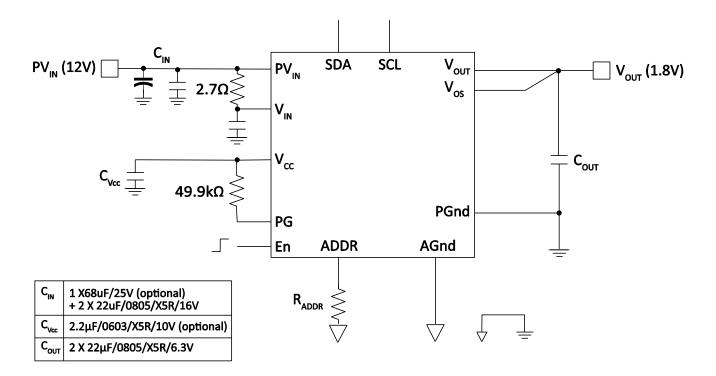


Figure 19 Application circuit for a single supply, PV_{IN}=12V, V_{OUT}=1.8V, 6A

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Typical operating waveforms

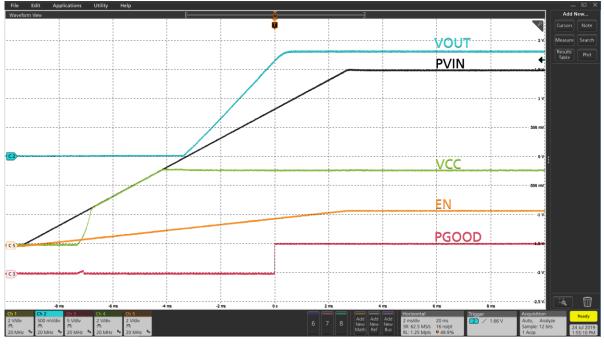


Figure 20 Startup with no load (Ch1:PVIN, Ch2: VOUT, Ch3: PGood, Ch4:VCC, Ch5: Enable)

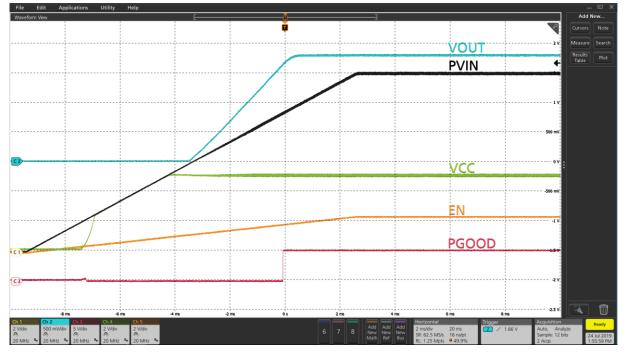


Figure 21 Startup with 6 A load (Ch1:PVIN, Ch2: VOUT, Ch3: PGood, Ch4:VCC, Ch5: Enable)

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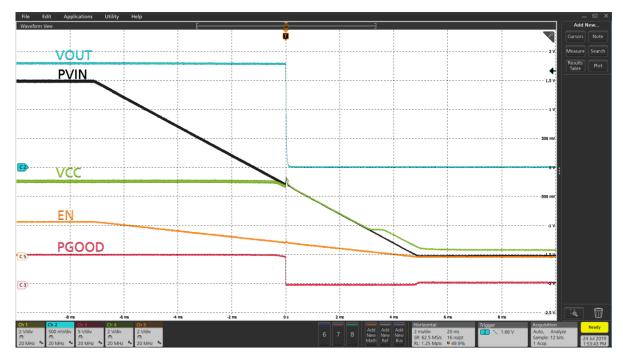


Figure 22 Shutdown with Enable de-assertion at 6A load (Ch1:PV_{IN}, Ch2: V_{OUT}, Ch3: PGood, Ch4:V_{CC}, Ch5: Enable)

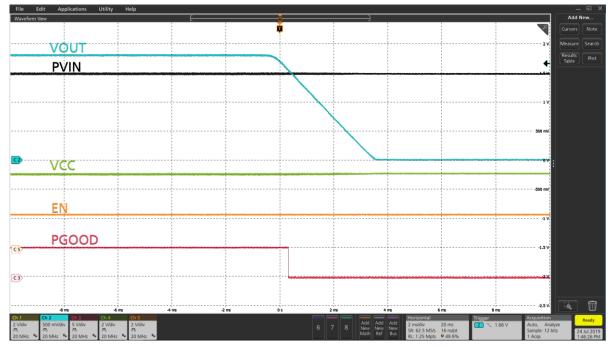


Figure 23 Soft turn off at no load (Ch1:PVIN, Ch2: VOUT, Ch3: PGood, Ch4:VCC, Ch5: Enable)

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FS1406 µPOL[™]

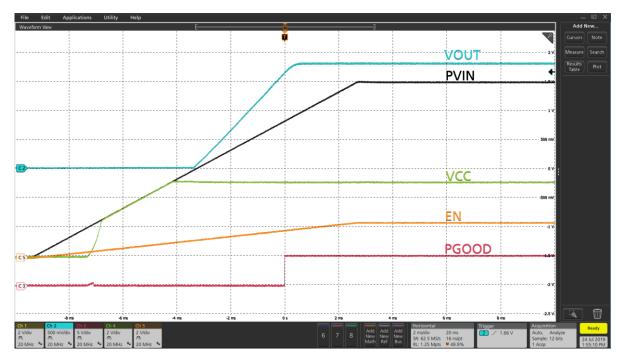


Figure 24 Startup with no load (Ch1:PV_{IN}, Ch2: V_{OUT}, Ch3: PGood, Ch4:V_{CC}, Ch5: Enable)

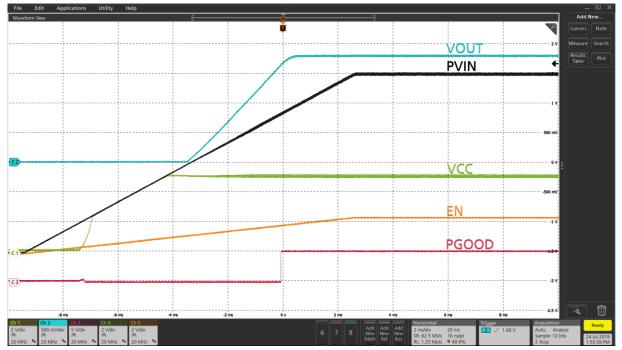


Figure 25 Startup with 6 A load (Ch1:PV_{IN}, Ch2: V_{OUT}, Ch3: PGood, Ch4:V_{CC}, Ch5: Enable)

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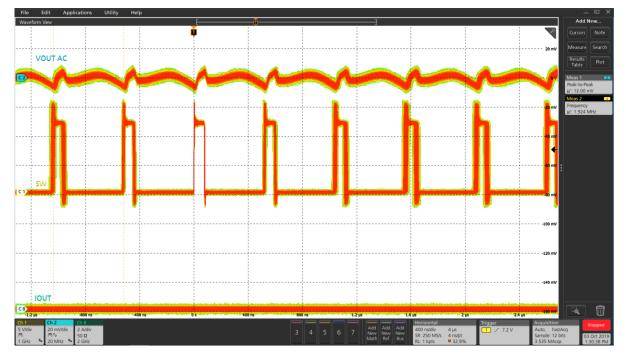


Figure 26 Vo ripple at OA (Ch8:10, Ch1: Sw, Ch2: Vout), Peak-Peak Vo ripple=12mV

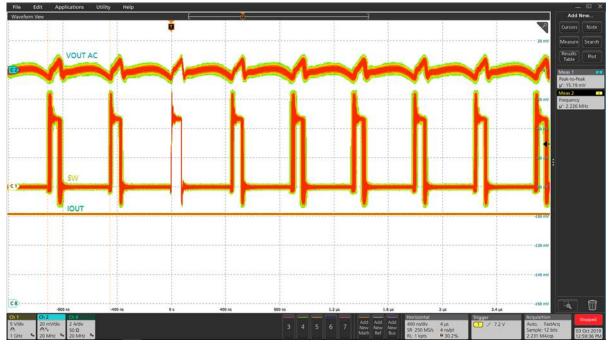


Figure 27 Vo ripple at 6A (Ch8:Io, Ch1: Sw, Ch2: Vout), Peak-Peak Vo ripple=15.19mV

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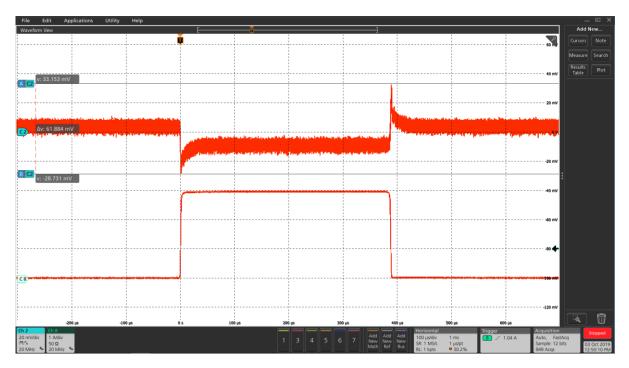


Figure 28 Transient response 0A to 3A (Ch6:Io, Ch2: Vout), peak-peak deviation=62mV

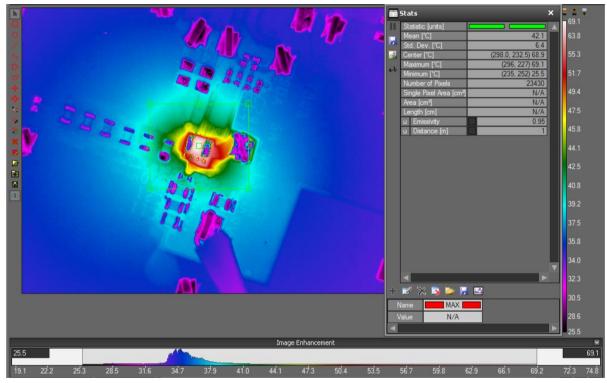


Figure 29 Thermal image at $PV_{IN} = 12V$, $V_{OUT} = 1.8V$, $I_O = 6A$, room temperature, no airflow, FS1406 maximum temperature = 69°C

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Layout recommendations

FS1406 is a highly integrated device with very few external components, which simplifies PCB layout. However, to achieve the best performance, these general PCB design guidelines should be followed:

- Bypass capacitors, including input/output capacitors and the V_{cc} bypass capacitor (if used), should be placed as close as possible to the FS1406 pins.
- Output voltage should be sensed with a separated trace directly from the output capacitor.
- Analog ground and power ground are connected through a single-point connection.
- To aid thermal dissipation, the PGnd pad should be connected to the power ground plane using vias. Copper-filled vias are preferred but plated-through-hole vias are acceptable, provided that they are not filled with resin or covered with solder mask.
- Adequate numbers of vias should be used to make connections between layers, especially for the power traces.
- To minimize power losses and thermal dissipation, wide copper polygons should be used for input and output power connections.
- SCL and SDA traces must be at least 10mil wide, with 20–30mil spacing between them.

Thermal considerations

The FS1406 has been thermally tested and modelled in accordance with JEDEC specifications JESD 51-2A and JESD 51-8. It has been tested using a 4-layer application PCB, with thermal vias under the device to assist cooling (for details of the PCB, refer to the application notes).

The FS1406 has two significant sources of heat:

- The power MOSFET section of the IC
- The inductor

The IC is well coupled to the PCB, which provides its primary cooling path. Although the inductor is also connected to the PCB, its primary cooling path is through convection. The cooling process for both heat sources is ultimately through convection. The PCB can be seen as a heat-spreader or, to some degree, a heat-sink.

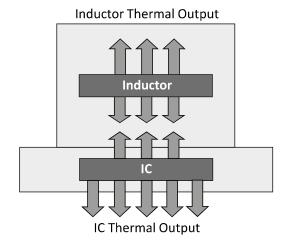


Figure 30 Heat sources in the FS1406

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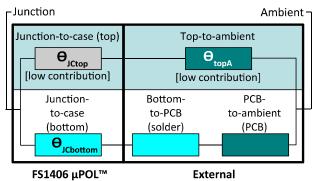


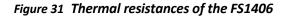
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FS1406 µPOL[™]

Figure 31 shows the thermal resistances in the FS1406, where:

- Θ_{IA} is the measure of natural convection from the assembled test sample within a confined enclosure of approximately 30x30x30cm. The air is passive within this environment and the only air movement is due to convection from the device on test.
- Θ_{JCbottom} is the heat flow from the IC to the bottom of the package, to which it is well coupled. The testing method adopts the method outlined in JESD 51-8, where the test PCB is clamped between cold plates at defined distances from the device.
- Θ_{JCtop} is theoretically the heat flow from the IC to the top of the package. This is not representative for the FS1406 for two reasons: firstly, it is not the primary conduction path of the IC and, more importantly, the inductor is positioned directly over the IC. As the inductor is a heat source, generating a similar amount of heat to the IC, a meaningful value for junction-to-case (top) cannot be derived.





The values of the thermal resistances are:

- **O**_{JA} = 22.6°C/W
- $\Theta_{JCbottom} = 2.36^{\circ}C/W$

Although these values indicate how the FS1406 compares with similar point-of-load products tested the same conditions using and specifications, they cannot be used to predict overall thermal performance. For accurate modeling of the µPOL™'s interaction with its environment, computational fluid dynamics (CFD) simulation software is needed to calculate combined routes of conduction and convection simultaneously.

Note: In all tests, airflow has been considered as passive or static; applications using forced air may achieve a greater cooling effect.

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I²C protocol

S P A N	= Stop bit = Ack			W = Write R = Read Sr = Repe	('0')			White Grey		=	Issued by ma Sent by slave		ŀOx)
Writ 1	te transaction 7	1	1	8	1	8	3 1	1					
S	Slave Address	W	A	Register Address	A	Data		P					
Rea 1	d transaction 7	1	1	8	1	1	7		1	1	8	1	1
S	Slave Address	W	Α	Register Address	Α	Sr	Slave Ad	dress	R	Α	Data Byte	Ν	Р

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Package description

The FS1406 is designed for use with standard surfacemount technology (SMT) population techniques. It has a positive (raised) footprint, with the pads being higher than the surrounding substrate. The finish on the pads is ENiG (Electroless Nickel Immersion Gold). As a result of these properties, the FS1406 works extremely well in lead-free environments. The surface wets easily and the positive footprint accommodates processing variations.

Note: Refer to the Design Guidelines for more information about TDK's µPOL[™] package series, including important guidance on checking the compatibility of manufacturing processes such as cleanable flux systems.

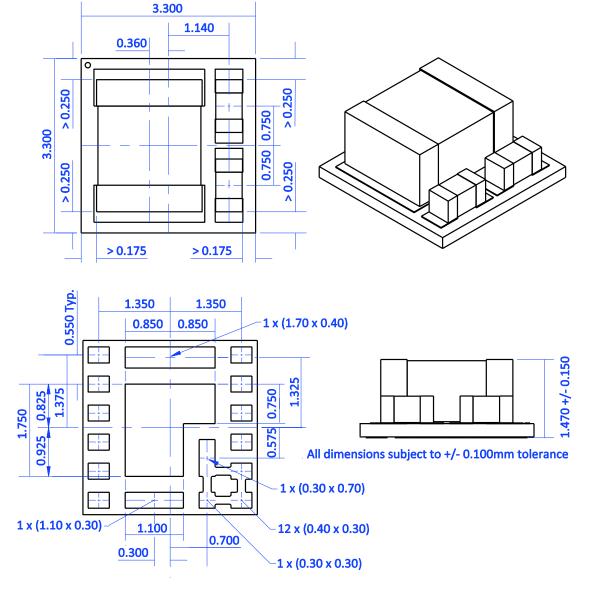


Figure 32 Dimensioned drawings

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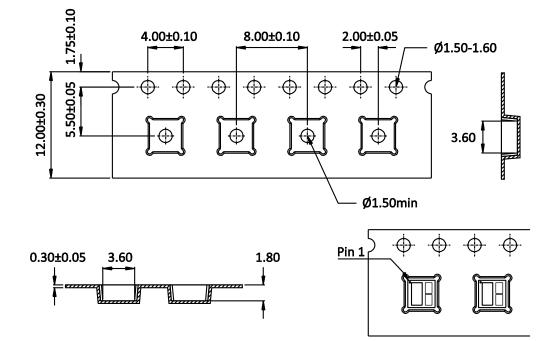
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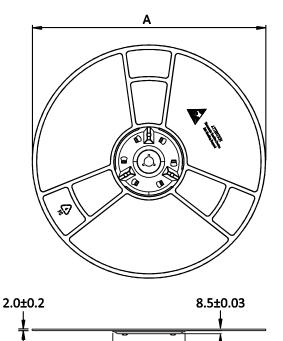




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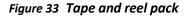
FS1406 μPOL[™]





102±1.0

Reel capacity (number of devices)	Reel diameter (dimension A)				
4000	330 ± 2.0				
250	178 ± 1.0				



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Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

REMINDER

The products listed on this specification sheet are intended for use in general electric equipment (AV equipment, telecommunication equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal condition and use condition.

The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to sociality, person or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification sheet.

- 1. Aerospace/Aviation equipment
- 2. Transportation equipment (cars, electric trains, ships, etc.)
- 3. Medical equipment
- 4. Power-generation control equipment
- 5. Atomic energy related equipment
- 6. Seabed equipment
- 7. Transportation control equipment
- 8. Public Information-processing equipment
- 9. Military equipment
- 10. Electric heating apparatus, burning equipment
- 11. Disaster prevention/crime prevention equipment
- 12. Safety equipment
- 13. Other applications that are not considered general-purpose applications

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- AU 3287379M 3287437AA 3290643AA 3291357AA
- CN 10371856C 10452610C 10458656C 10459360C 10465848C 1069332A 11124619A 11346682A 1685299A 1685459A 1685582A 1685583A 1698023A 1802619A
- EP 1561156A1 1561268A2 1576710A1 1576711A1 1604254A4 1604264A4 1714369A2 1745536A4 1769382A4 1899789A2 1984801A2
- US 20040246754 2004090219A1 2004093533A1 2004123164A1 2004123167A1 2004178780A1 2004179382A1 20050200344 20050223252 2005209373A1 20060061214 2006015619A1 20060174145 20070226526 20070234095 20070240000 20080052551 20080072080 20080186006 6741099 6788036 6936999 6949916 7000125 7049798 7069021 7080265 7249267 7266709 7315156 7372682 7373527 7394445 7456617 7459892 7493504 7526660
- WO 04044718A1 04045042A3 04045042C1 04062061A1 04062062A1 04070780A3 04084390A3 04084391A3 05079227A3 05081771A3 06019569A3 2007001584A3 2007094935A3

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